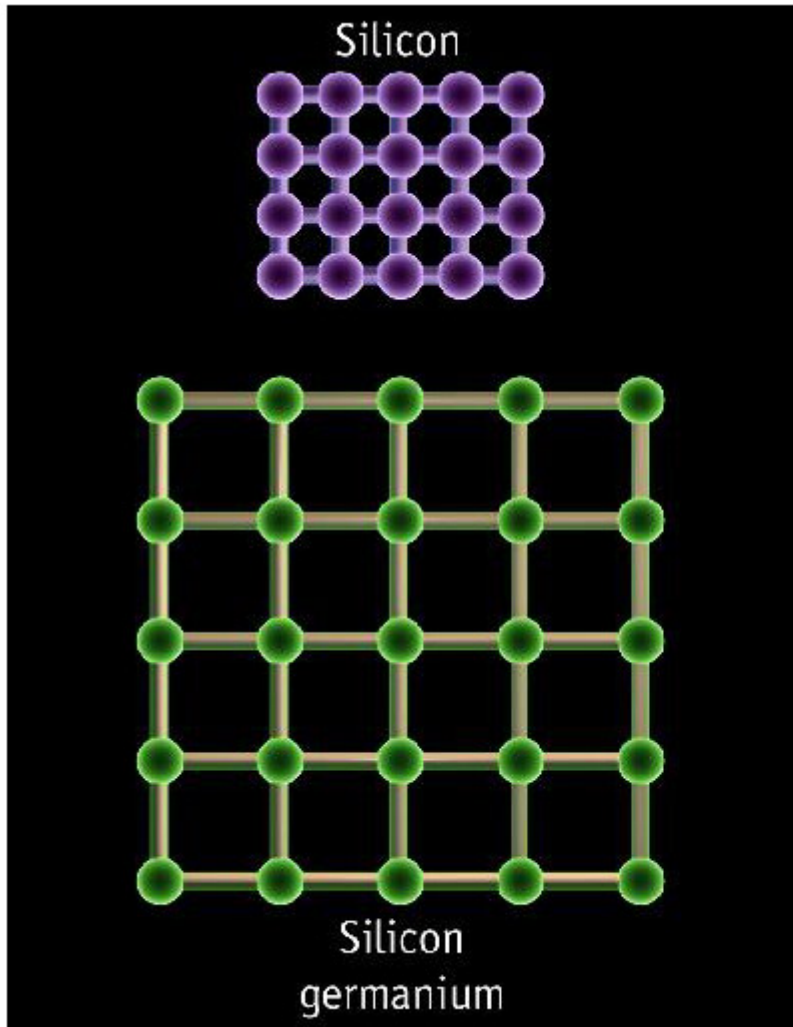
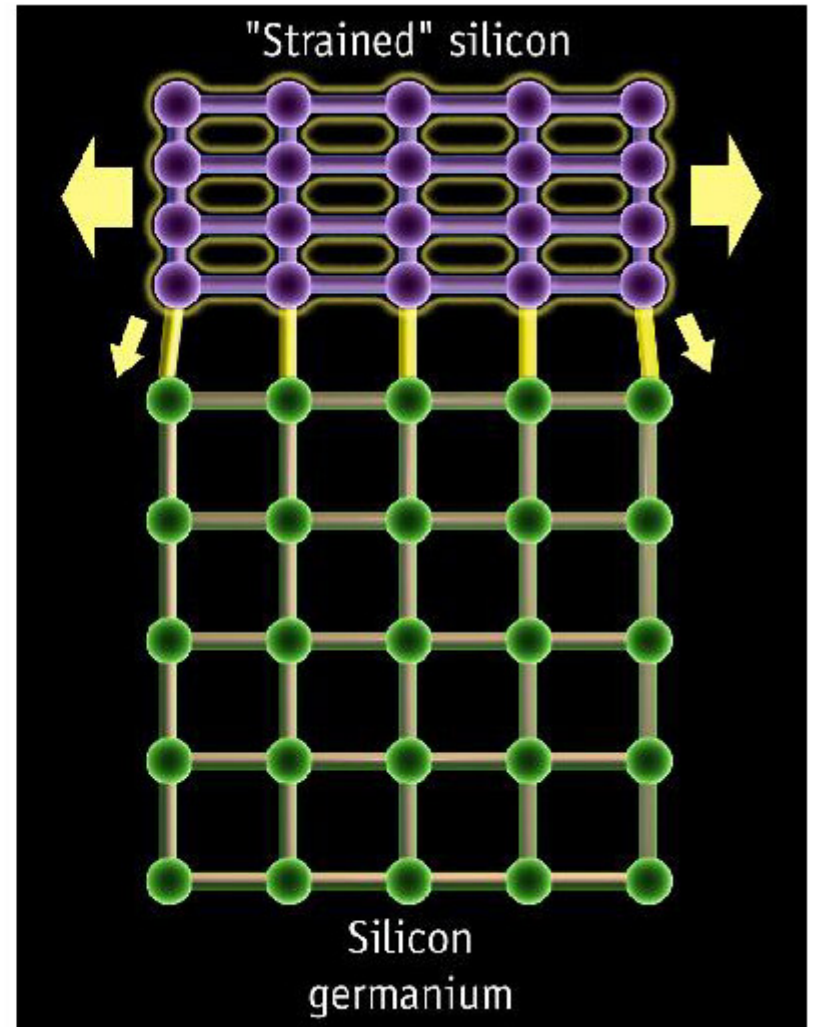


# Strain at interfaces



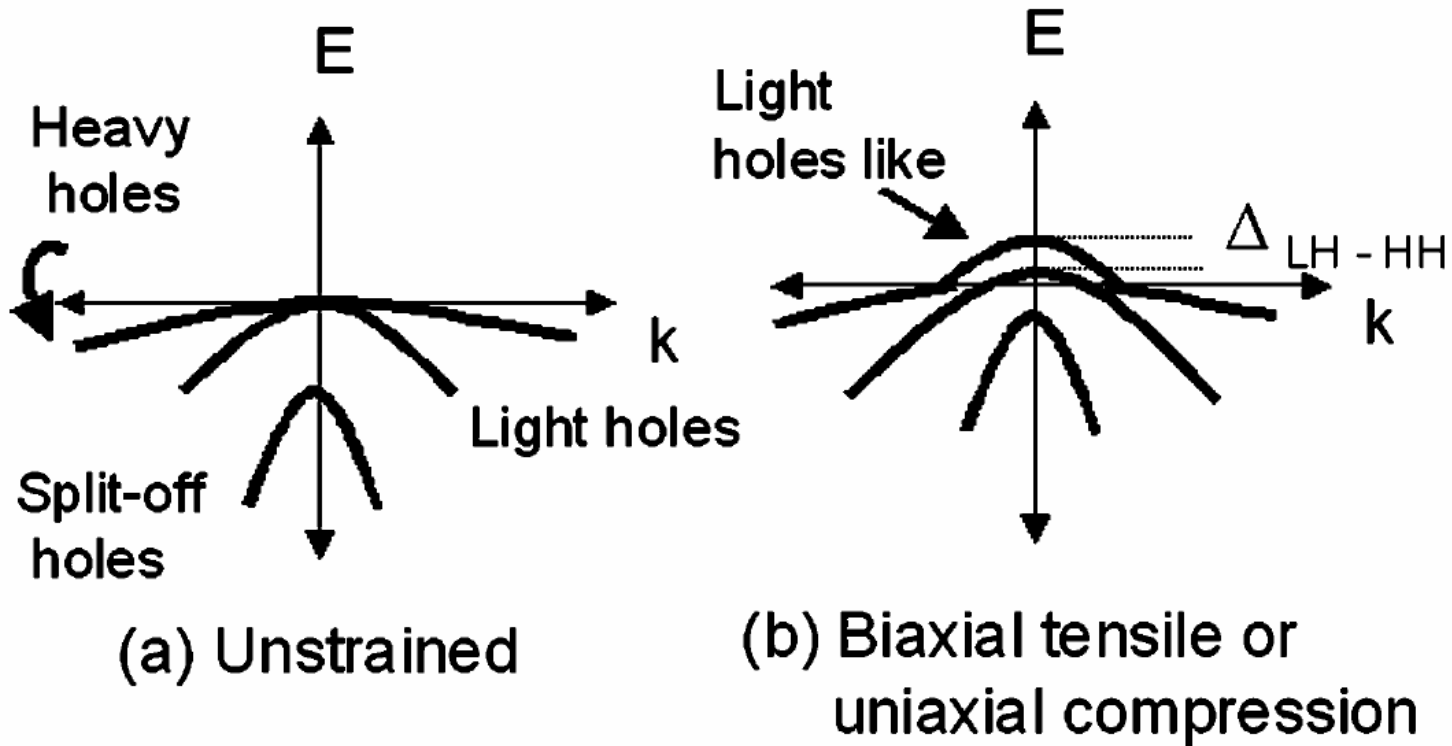
Before:  $a=a_0$



After:  $a>a_0$ , tensile strain  
 $a<a_0$ , compressive strain

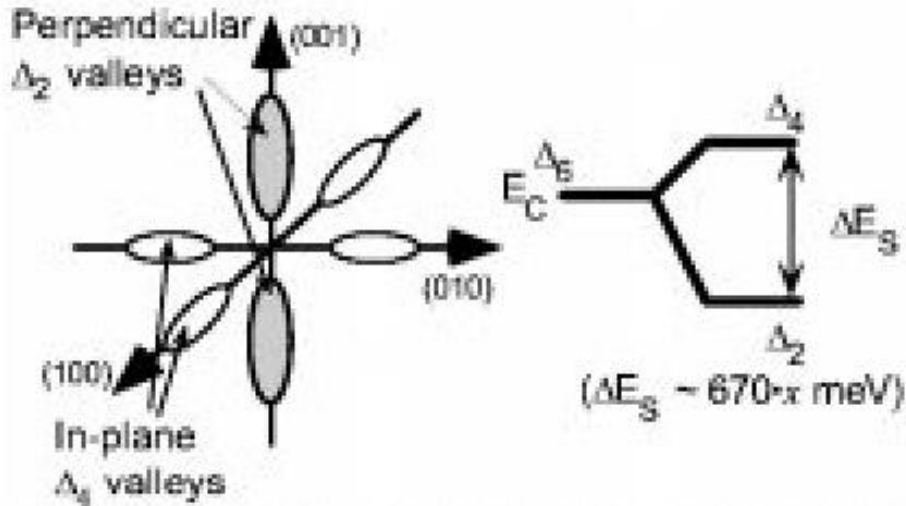
# Effects of strain on holes

## Longitudinal In-plane Direction



$m^* \downarrow$ , interband scattering  $\downarrow \Rightarrow \tau \uparrow \Rightarrow \mu = e\tau/m^* \uparrow$   
 for both tensile and compressive strain

## Effects of strain on electrons



(c) biaxial tensile strain-induced  $E_C$  splitting in Si

Curvature doesn't change,  
but 6-fold valley degeneracy lifted

Compressive strain lowers the energy band in the direction of the strain  
Tensile strain raises the energy band in the direction of the strain

$$m^* = m_t, \text{ intervalley scattering} \downarrow \Rightarrow \tau \uparrow \Rightarrow \mu = e\tau/m^* \uparrow$$

for tensile strain only